

Temperature increase of main components

Model: MGW648□□

1. Conditions

- (1) Input :DC 48 [V]
 (2) Output :Rated output
 (3) Cooling method :Convection cooling
 (4) Mounting method :Shown as Fig.1.1

2. Result

Table 2.1 Temperature increase of main components

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No.	Parts name	Symbol No.	Increase (ΔT)		Rated temp. [°C]	Reference
			[deg]			
			±12V	±15V		
1	Switching MOS-FET	TR11	27	25	150	Junction Temp.
2	Power control IC	IC11	27	26	150	Junction Temp.
3	Rectified diode (Output)	D201	32	30	150	Junction Temp.
4	Photocoupler	PC11	27	26	125	Junction Temp.
5	Transformer (PCB)	P2	30	28	130	
6	CASE	CASE	28	25	105	Top Surface Center
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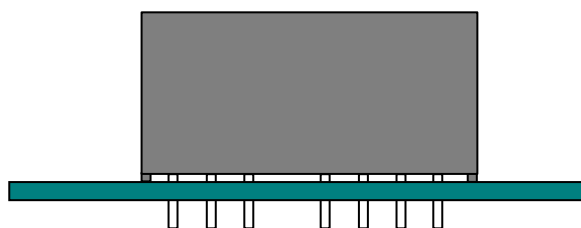


Fig.1.1 Mounting method